

Commercial-ready particle detector technologies at IMB-CNM (CSIC)

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Major renewal of Clean Room equipment

- 14 M€ FEDER + CSIC
- Upgrade to complete 150 mm wafer fabrication line
- Most of the equipments doubled to avoid contamination
 - CMOS-like line
 - Noble Metal allowed
- Nanofabrication line

We have now the capability to fabricate particle detectors in 150 mm both in Silicon and Silicon Carbide



New furnaces, 12 tubes, atmospheric and low pressure

ISO9011:2015 certification

- We obtained (May 2023) the ISO900:2015 certification
- The scope is restricted to commercial contracts, either from CSIC or D+T
- Research and self-service accesses are not considered

This is a new level of quality in IMB-CNM fabricated detectors and we will be able to reach new more demanding customers



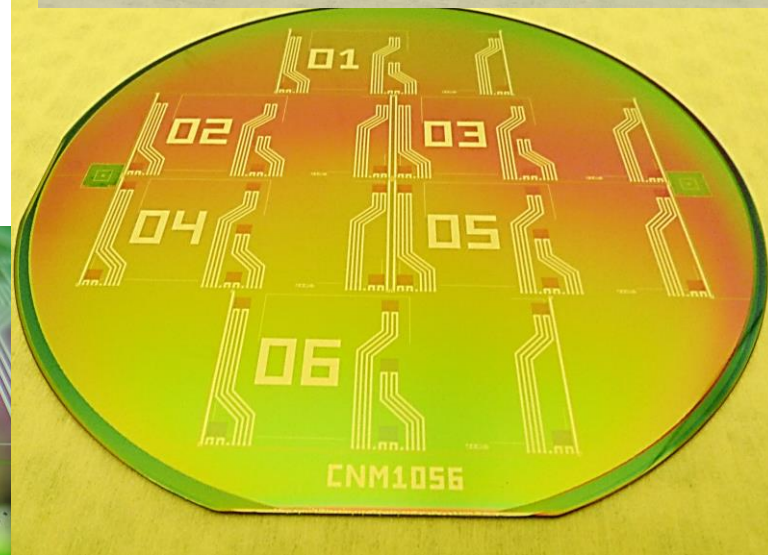
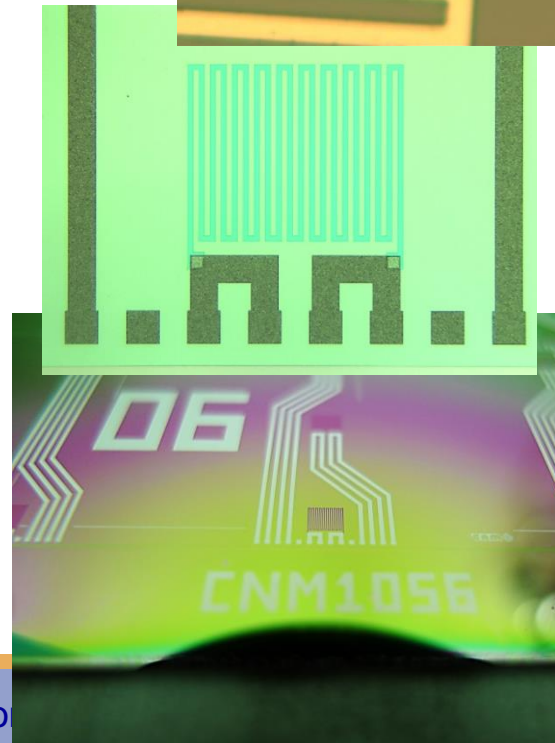
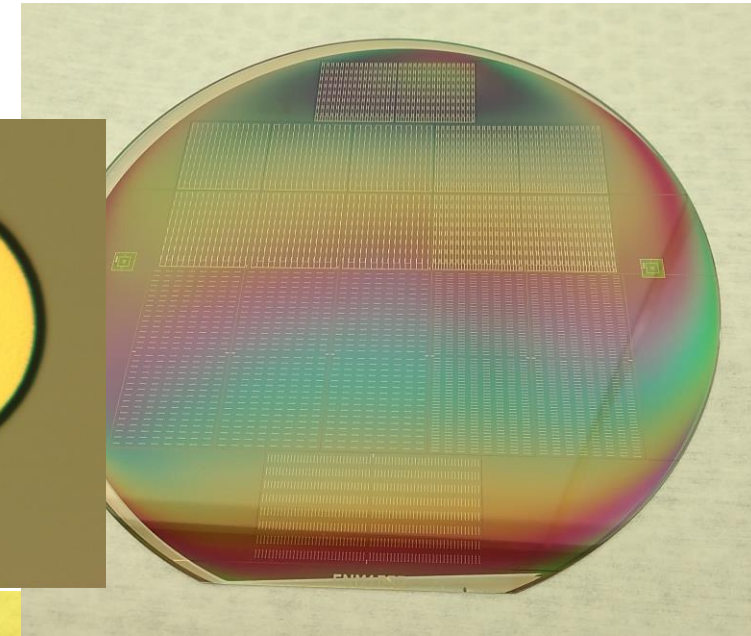
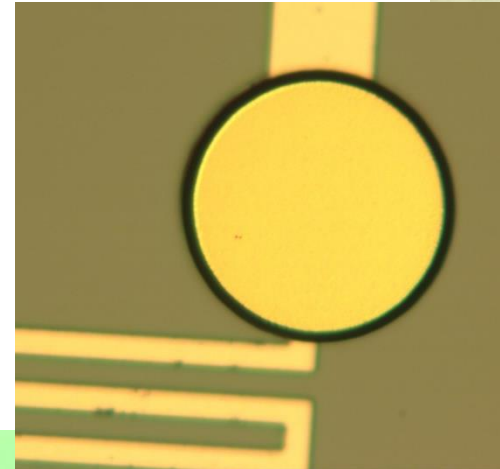
Scope:

- 1) Design and development oriented towards the production of devices based on nano- and microelectronic technologies manufactured in the micro and nano-manufacturing facilities of the IMB-CNM within the framework of commercial contracts.
- 2) Production of devices based on nano- and microelectronic technologies in the IMB-CNM micro- and nano-manufacturing facilities within the framework of commercial contracts

Dummy detectors & pitch adaptors

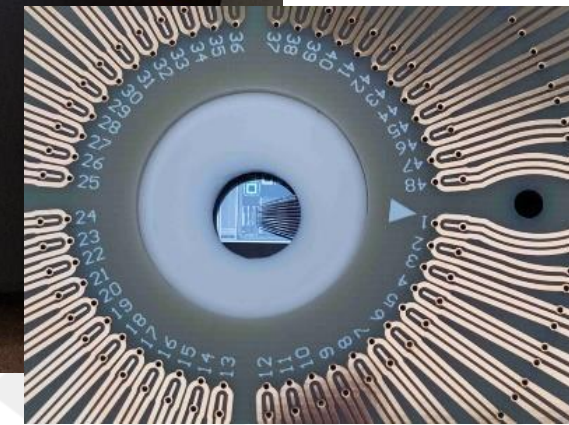
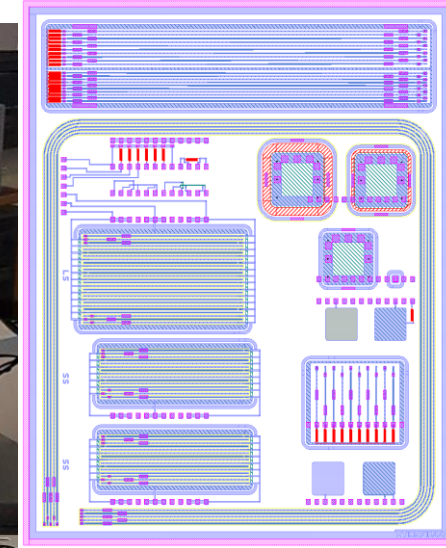
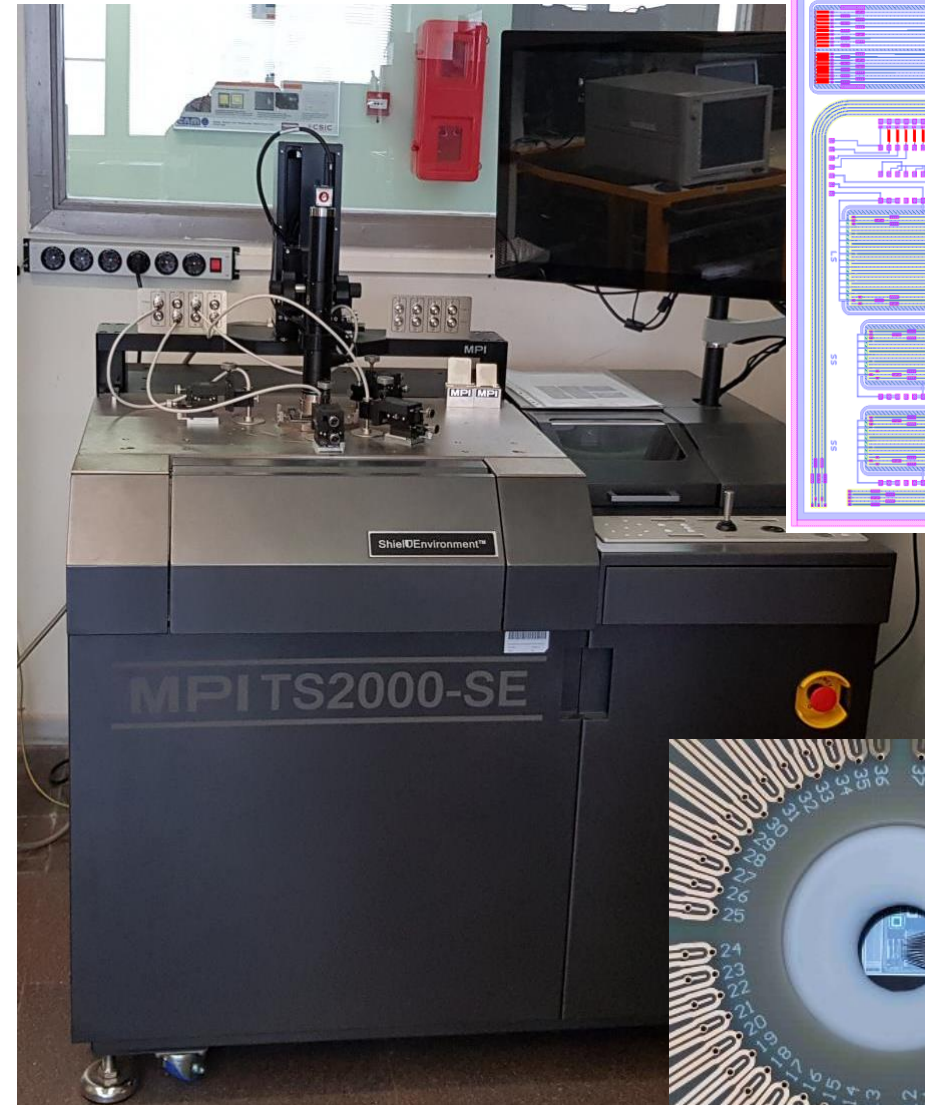
- Dummy structures to the reliability of flip-chip connections with the readout electronics at CMS
- Manufactured in 150 mm wafers

- Dummy structures for the study of thermal dissipation of the ATLAS HGTD system detectors
- They include resistors with a value dependent on temperature.

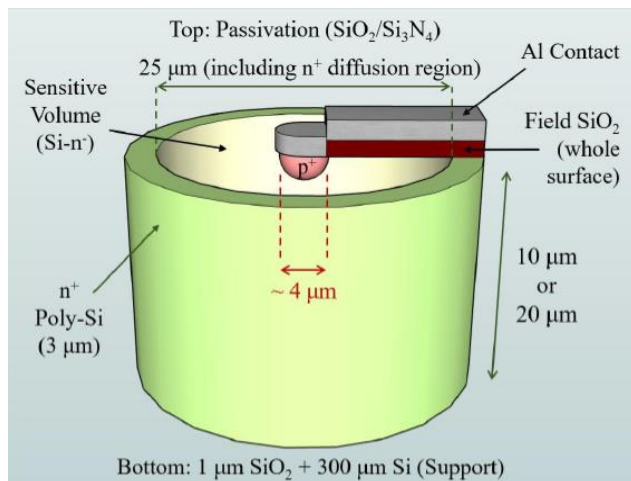
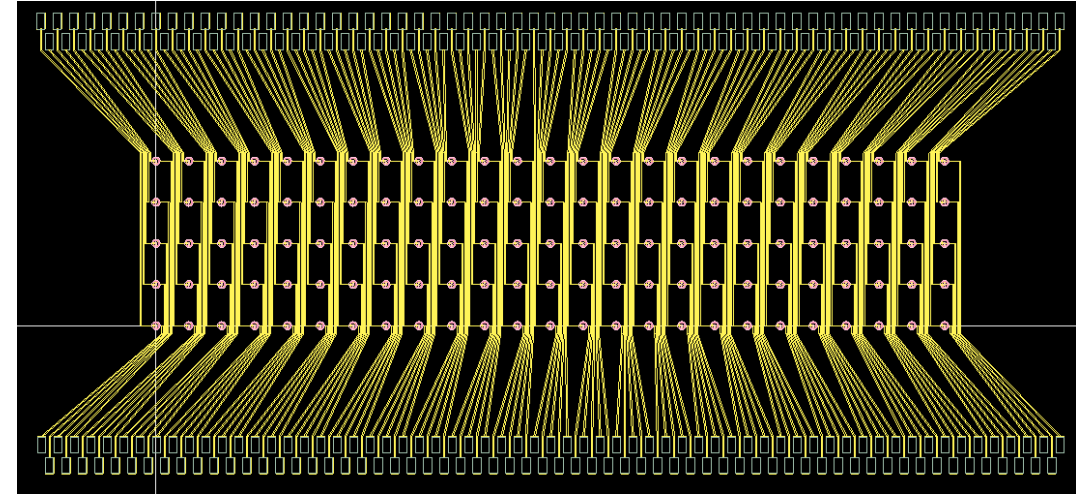
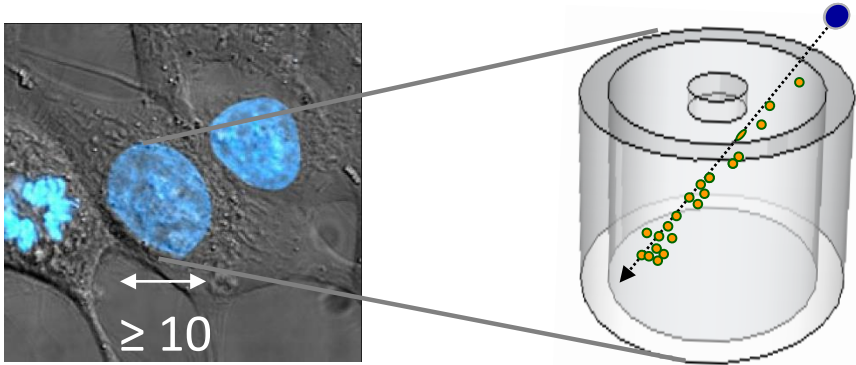


Microstrip sensors

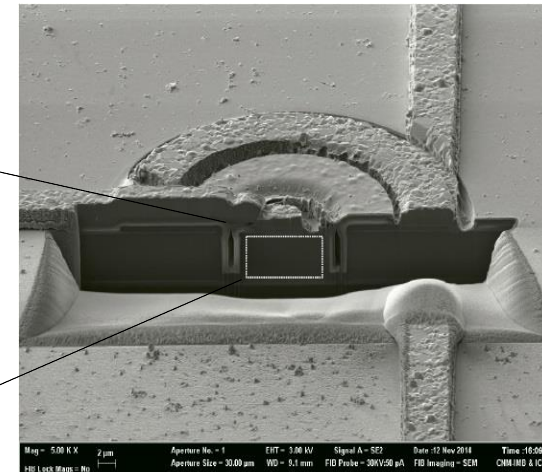
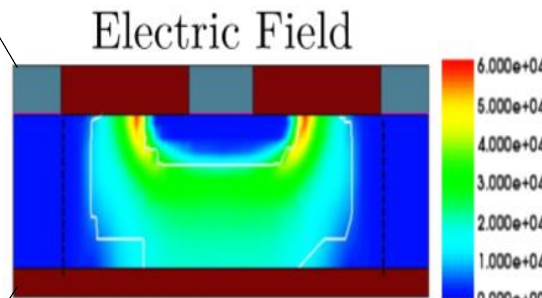
- ❑ Particle Physics and Nuclear experiments
- ❑ Optimized, production-ready, large area, strip sensor technology on 150 mm substrates with advanced technological options of interest in future Physics experiments
- ❑ Currently 2 metal levels, working for a 3rd metal level
- ❑ Fully automatic technology and device **quality assurance (QA) testing** using specific **test structures** and automatic **characterization and analysis** methods



Microdosimeters



*C. Guardiola et al.,
Brevet ref: PCT/ES2015/070056*



Diameters: 9, 10, 15, 20, 25 μm
Thickness: 5, 10, 20 μm

3D Detectors

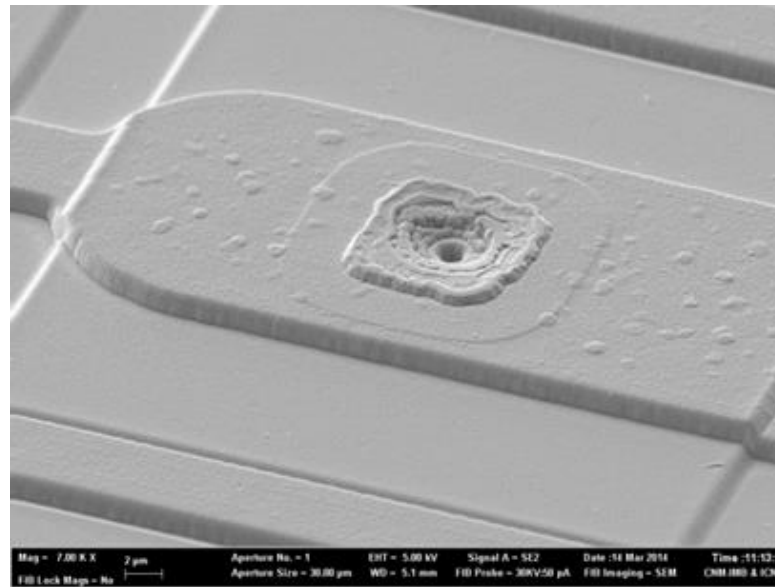
Installed at CERN experiments:

- ❑ Atlas IBL (Insertable b-Layer, 50% fabricated at CNM)
- ❑ AFP (ATLAS Forward Proton, 100% fabricated at CNM)
- ❑ CT-PPS (CMS-TOTEM Precision Proton Spectrometer, 100% fabricated at CNM)

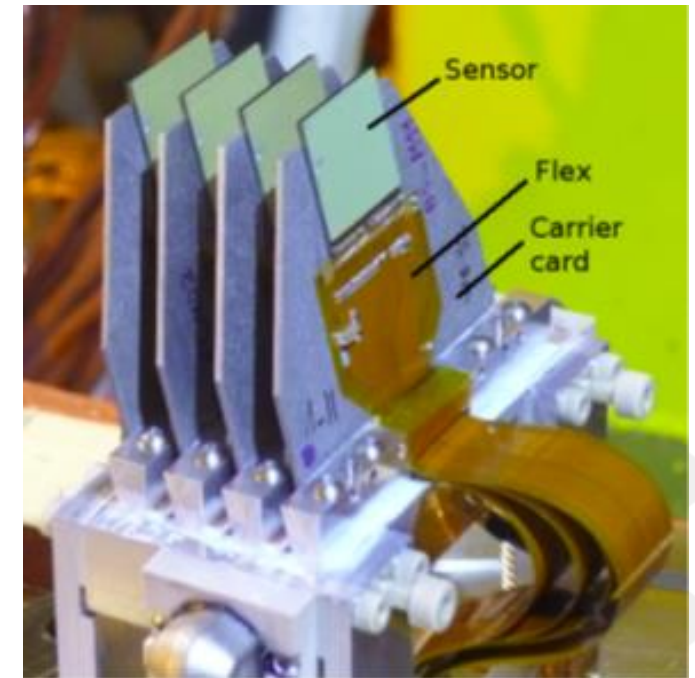
**Working to adapt
3D technology to SiC**



ATLAS IBL

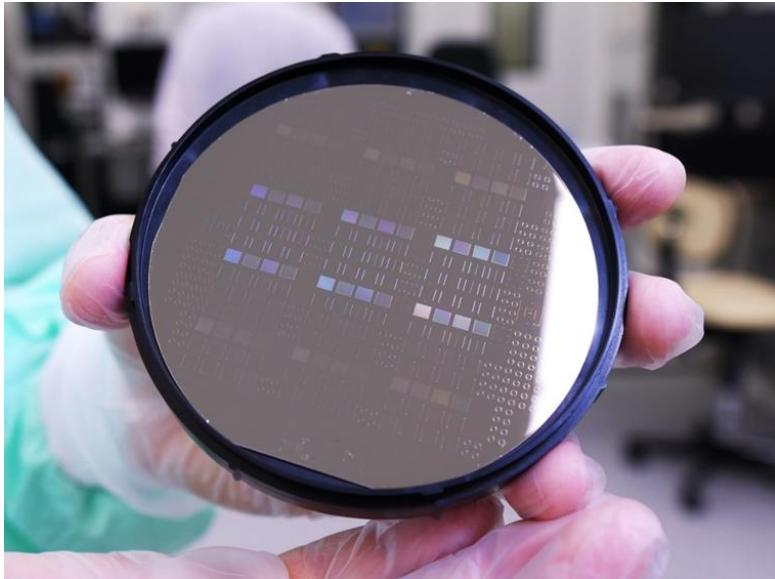


CMS CT-PPS Detectors



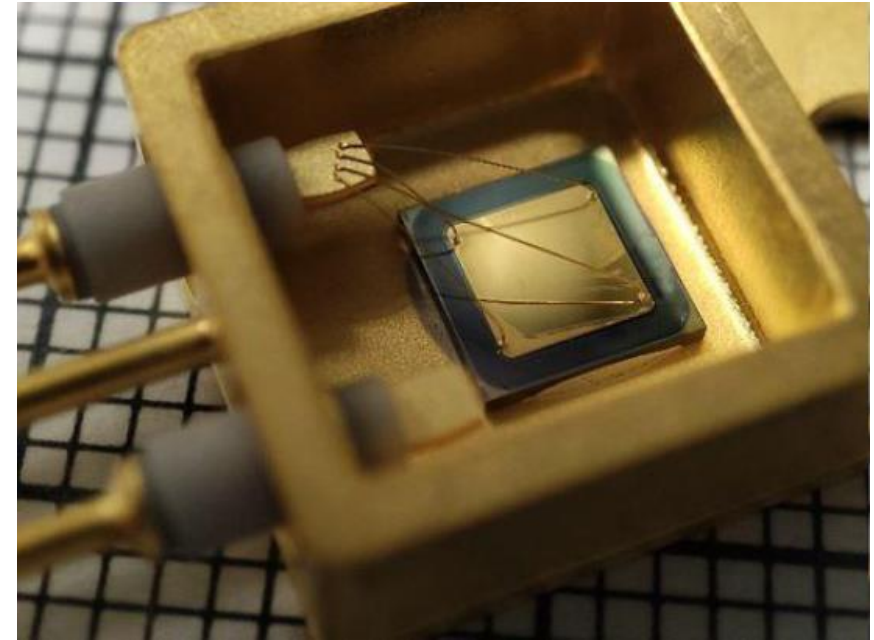
AFP detectors with slim edges

SiC radiation detectors & blocking diodes



Detectors and package optimized to work up to 500°C

150 mm wafers



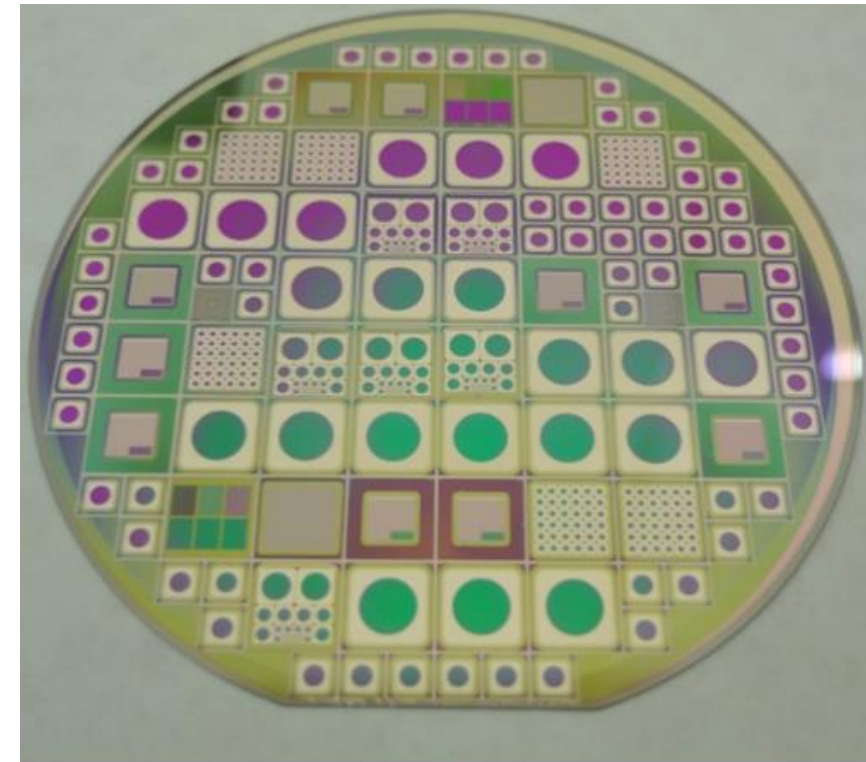
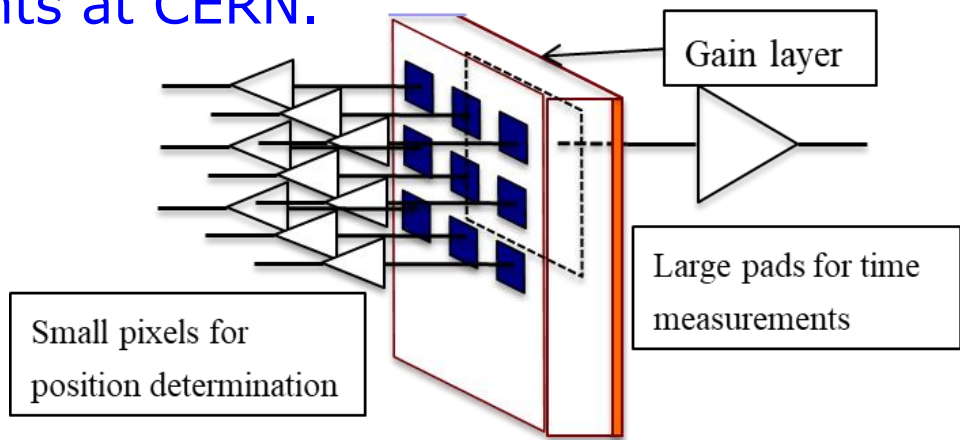
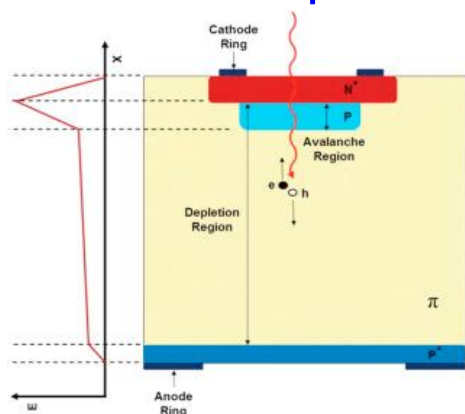
- **Space:** deep UV detectors (ESA) and blocking diodes
- **Dosimetry:** solid state ionisation chambers detecting x-rays or hadrons (FLASH)
- **Synchrotrons:** solid state ionisation chambers and fluorescence detectors
- **Heavy ions:** start detectors and spectroscopy (e.g. GSI and the Nordhja)
- **Neutron detection:** nuclear industry, research and dosimetry
 - Thermal neutrons: fluence and profile monitoring
 - Fission neutrons: nuclear
 - Fusion: Tokamaks



Low Gain Avalanche Detectors (LGAD)

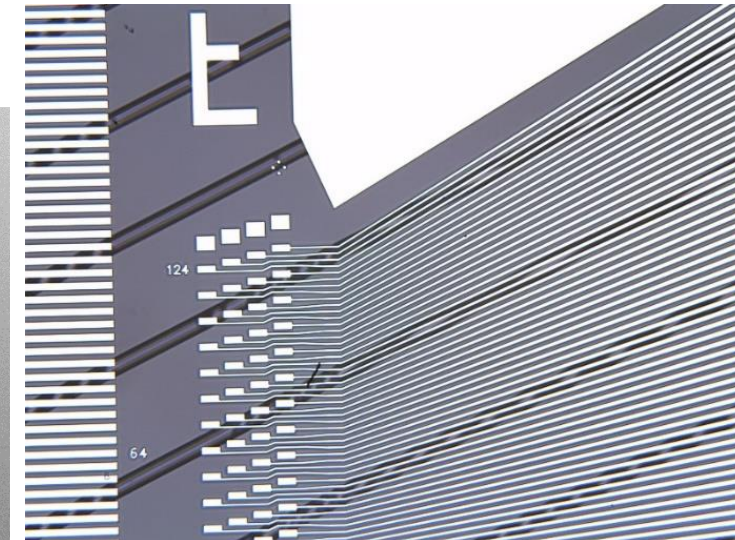
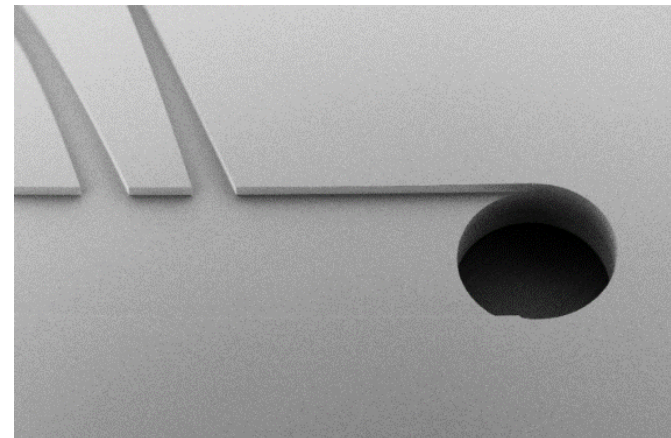
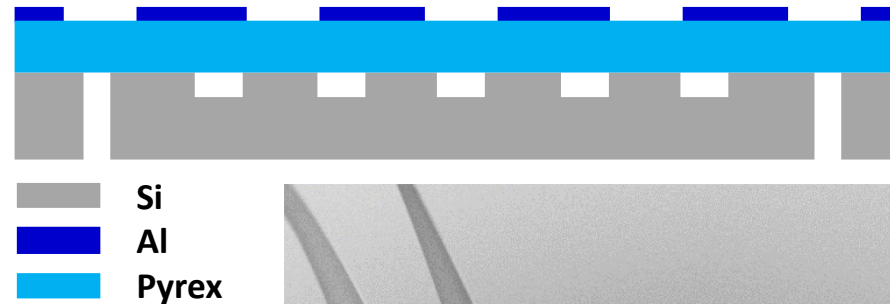
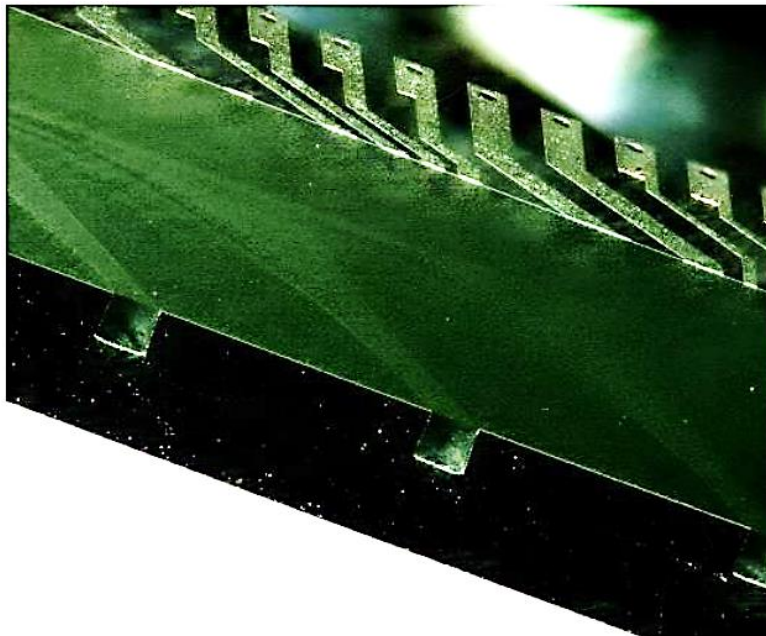
- Featuring an **internal moderate gain**
- Optimized for excellent **time ($\approx 20\text{ps}$) and spatial resolutions ($\approx 50\mu\text{m}$)**
- Could lead to the **detection of single ions** and to count the number of beam particles with high precision, improving the indirect measure provided by ionization chambers.
- Technology developed at CNM and now the baseline for different experiments at CERN.

Working to adapt 3D technology to SiC



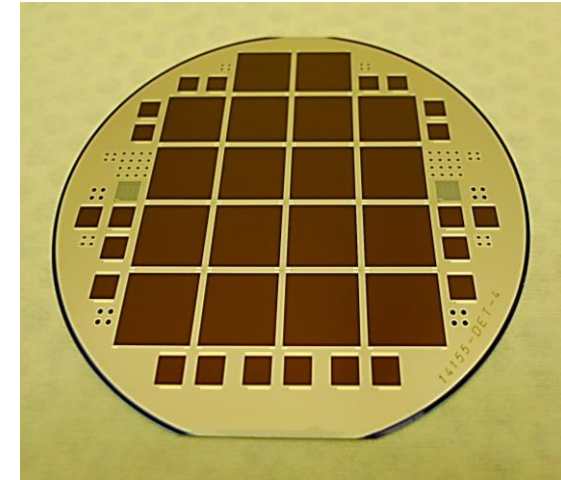
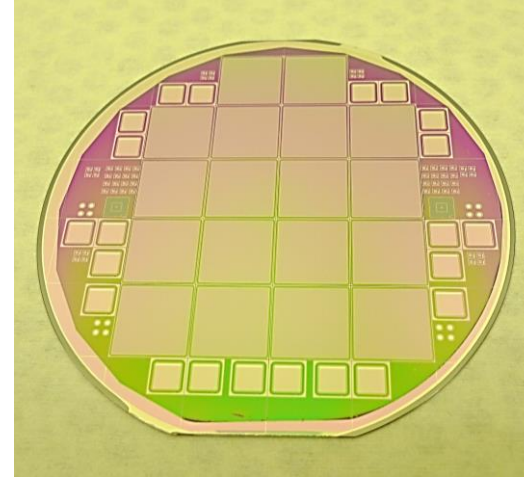
Microchannel cooling for radiation detectors

- Creation of silicon "interposers" which integrate microchannels for efficient heat dissipation in detector systems with high thermal demands together with metal layers for signal and power redistribution
- Applications in photonic science (synchrotrons and free-electron lasers) and in particle physics



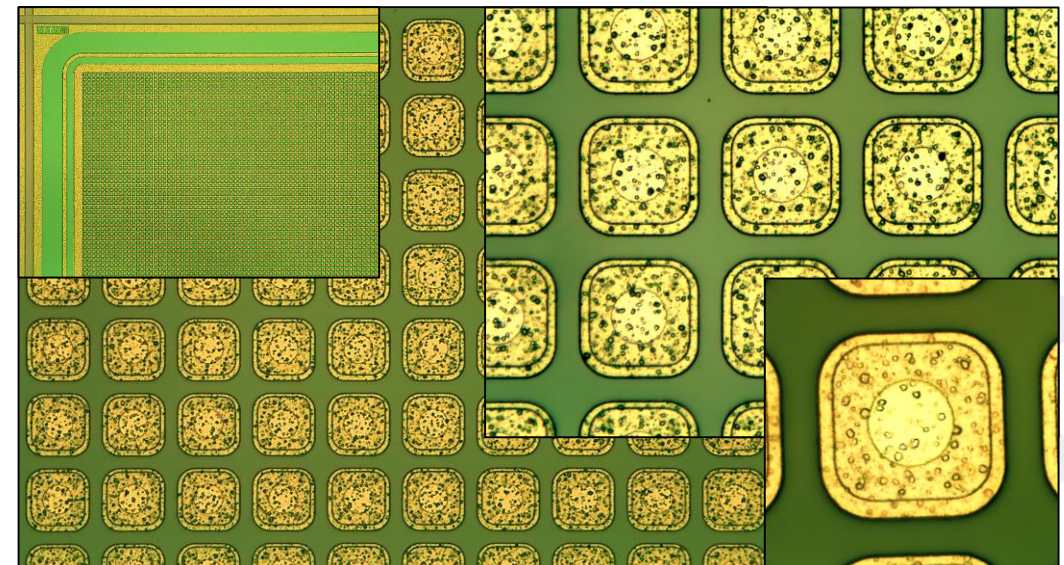
Ultra thin entrance window pixel detectors

- ❑ Ultra thin entrance window
- ❑ Pixel detectors for Medipix TPX chips
- ❑ For very low energy electron detection



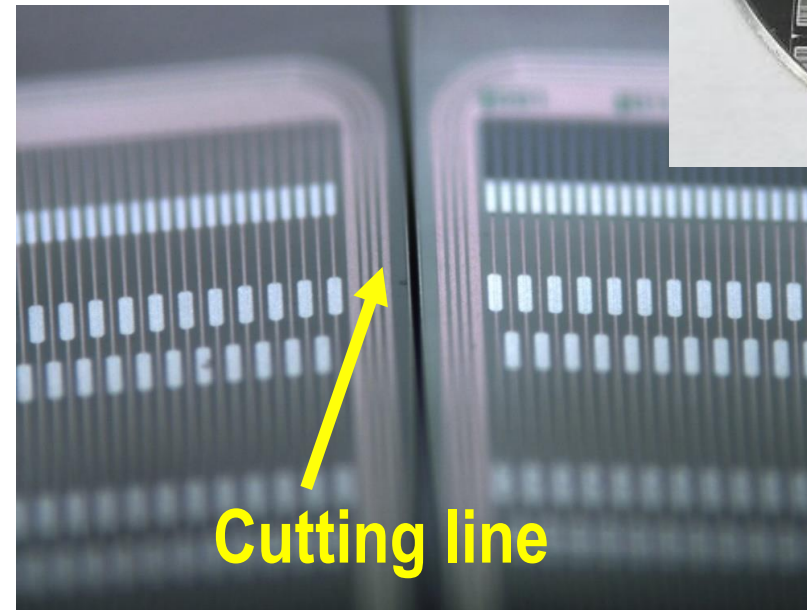
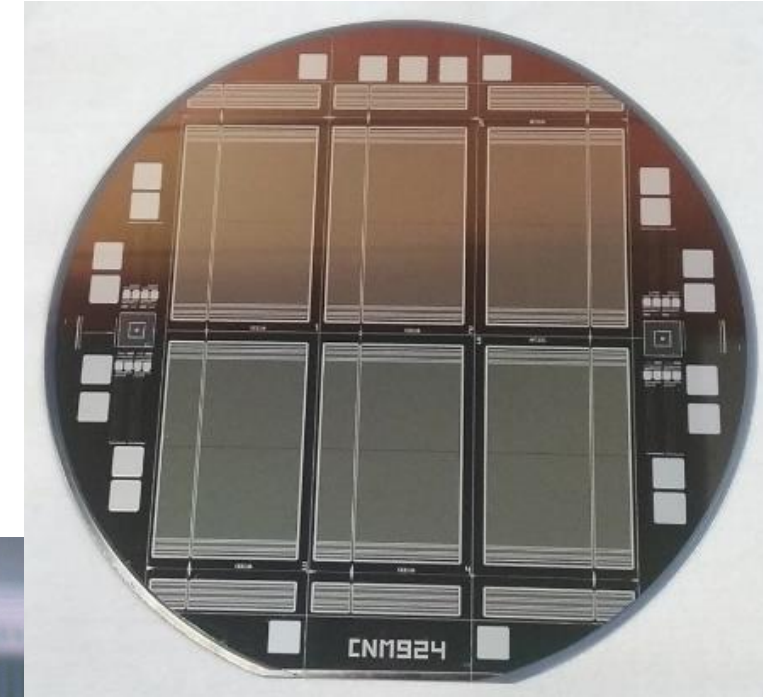
AMSTERDAM
SCIENTIFIC
INSTRUMENTS

Amsterdam Scientific Instrumentation (NL)



Thin edge microstrip detectors

- ❑ Microstrip detectors
- ❑ Thin edge microstrip detectors for HPS (Heavy Proton Search)
- ❑ Coupling capacitor improved technology
- ❑ Cleaving



SLAC

**SLAC National Accelerator
Laboratory (USA)**